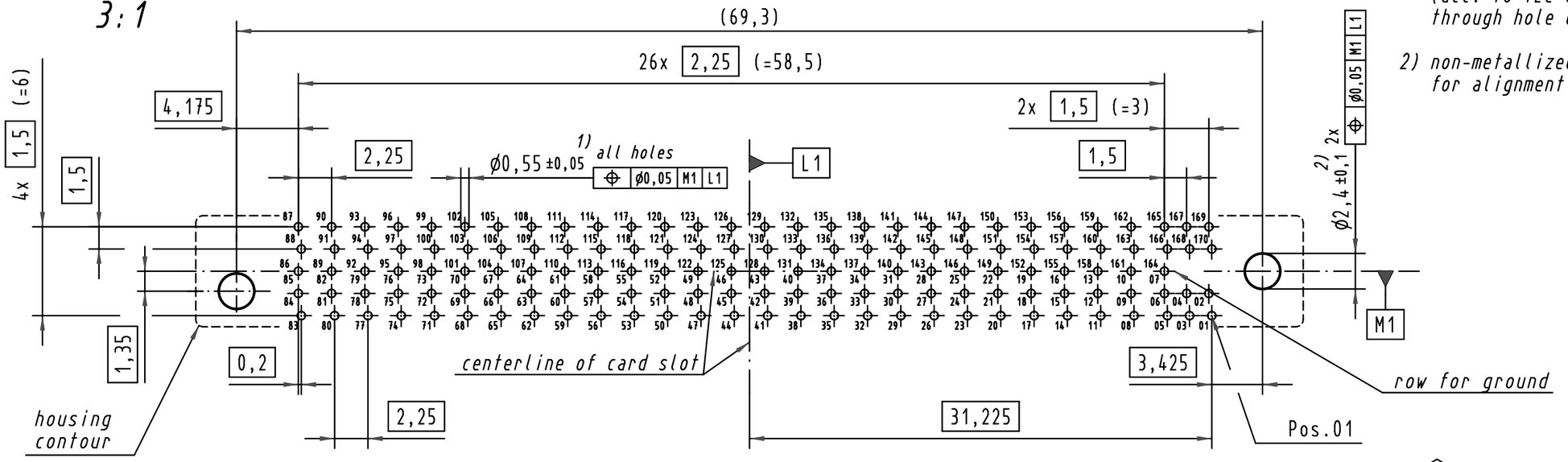
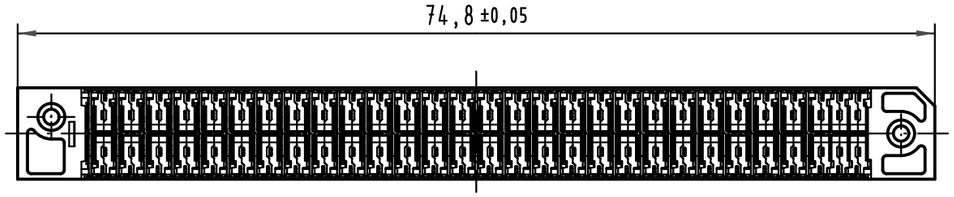
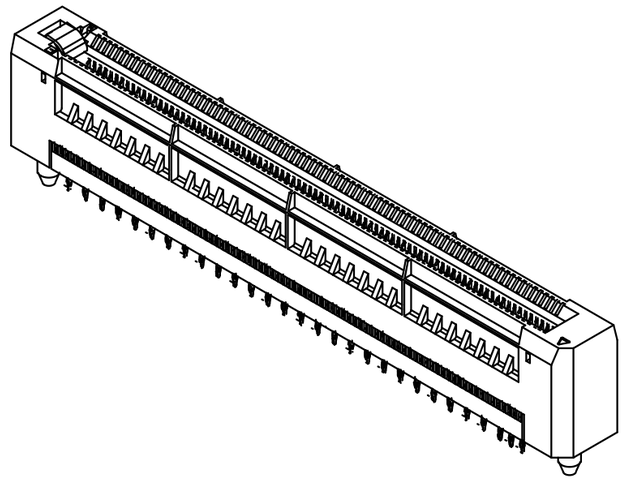
Board Layout
3:1

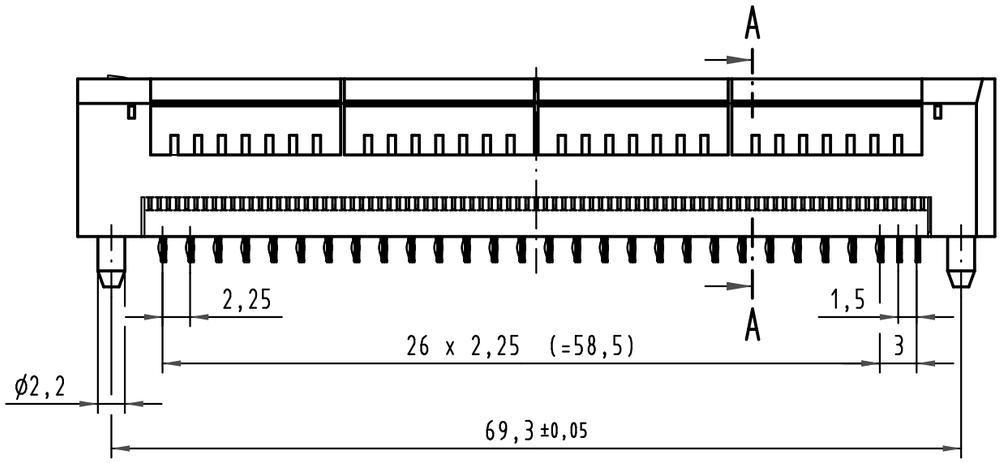
1) recommended drill hole Ø0,64±0,01mm
(acc. to IEC 60352-5)
through hole dia. (after plating): Ø0,55±0,05

2) non-metallized drillings
for alignment pegs

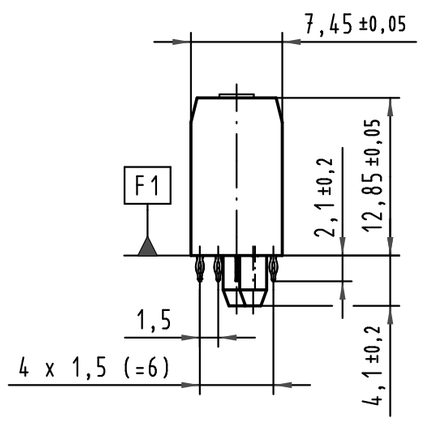


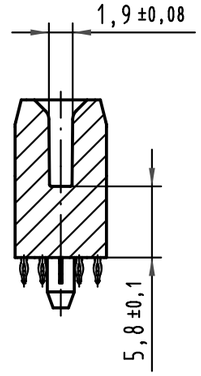


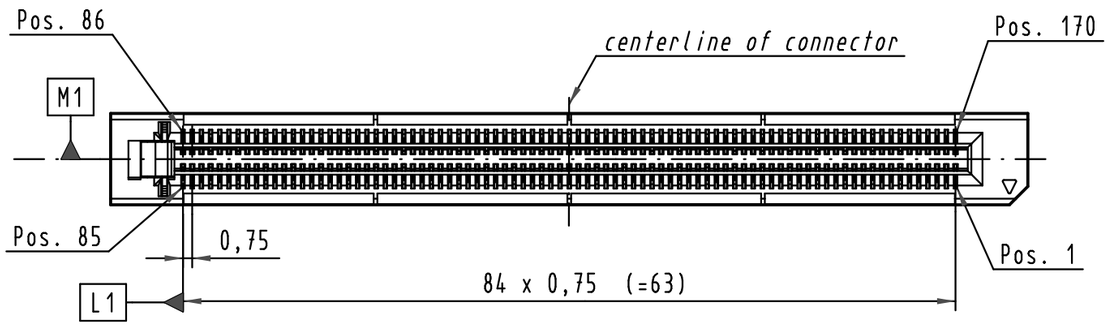




A-A







missing dimensions and information acc. to PICMG MicroTCA.0
(Micro Telecommunications Computing Architecture Base Specification)

con:card+

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maße/ *Free size tolerances*
				Dat.	Name	Maßstab/*Scale*
			Detail.	25.09.09	hsv	2 : 1
			Insp.	25.09.09	Lue.	3:1
			Stand.			**AdvancedMC connector for MicroTCA 170 pole, press-fit with alignment pegs**
			HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP			TB 16 11 170 5206 000
35928						Blatt/ *page* /
Mod.	Dat.	Name				Sub.

Alle Rechte vorbehalten/ All rights reserved